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Form PTO-1595  
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OMB No. 0651-0011 (exp. 4-30-05)

U.S. Department of Commerce  
Patent and Trademark Office

RECO

To the Honorable Commissioner of Patents and Trademarks. Ple

1. Name of conveying party(ies):  
Uwe Rudolph  
Martin Seck  
Armin Tilke  
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):  
Name: Infinion Technologies AG  
Street Address: St. Martin-Strasse 53  
City: 81669 München  
Country: Germany  
Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of Conveyance:  
☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other  
Execution Date(s): 10/07/04, 10/11/04, 01/01/05

4. Application number(s) or patent number(s):  
If this document is being filed together with a new application, the execution date of the application is  
A. Patent Application No(s) 10/916,774  
B. Patent No(s)  
Additional numbers attached? ☐ Yes ☒ No  
Title of Invention: Polysilicon Bipolar Transistor and Method of Manufacturing It  
Our Docket No.: 1890-0115

5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: Harold C. Moore  
Internal Address: Maginot, Moore & Beck  
Street Address: 111 Monument Circle, Suite 3000  
City: State: Zip: Indianapolis, IN 46204-5115

6. Total number of applications and patents involved  
1

7. Total fee (37 CFR 3.41): \$ 40.00  
☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit Account number: 13-0014  
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*  
Harold C. Moore  
Name of Person Signing  
Registration No. 37,892  
[Signature]  
Signature  
January 17, 2005  
Date  
Total number of pages including cover sheet, attachments and document 7

Mail documents to be recorded with required cover sheet information to:  
Mail Stop Assignment Recordation Services, Commissioner for Patents  
P.O. Box 1450, Alexandria, VA 22313-1450

01/24/2005 SDENB081 00000037 10916774

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PATENT  
REEL: 016175 FRAME: 0476

REF NO. IO030111PUS  
MMB REF NO. 1890-0115

ASSIGNMENT

For good and valuable consideration, I, Uwe Rudolph, a citizen of Germany, residing at Altomsewitz 1e, 01157 Dresden, Germany, Martin Seck, a citizen of Germany, residing at Edeltraudstrasse 4, 81827 München, Germany, and Armin Tilke, a citizen of Germany, residing at Helgolandstrasse 4, 01097 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on August 12, 2004 US. Serial No. 10/916,774

entitled: Polysilicon Bipolar Transistor and Method of Manufacturing It

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: Uwe Rudolph DATE: 07.10.2004  
NAME: Uwe Rudolph

SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_  
NAME: Martin Seck

1-01-05

14:31

VON -SCHOPPE & ZIMMERMANN

+49-89-74996977

T-669 P.008/016 F-415

REF NO. IO030111PUS  
MMB REF NO. 1890-0115

SIGNATURE:

NAME: Armin Tilke

DATE:

REF NO. IO030111PUS  
MMB REF NO. 1890-0115**ASSIGNMENT**

For good and valuable consideration, I, Uwe Rudolph, a citizen of Germany, residing at Altomsewitz 1e, 01157 Dresden, Germany, Martin Seck, a citizen of Germany, residing at Edeltraudstrasse 4, 81827 München, Germany, and Armin Tilke, a citizen of Germany, residing at Helgolandstrasse 4, 01097 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

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and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

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SIGNATURE:

NAME: Uwe Rudolph

DATE:

SIGNATURE:

NAME: Martin Seck

DATE:

REF NO. IO030111PUS  
MMB REF NO. 1890-0115

SIGNATURE:

NAME: Armin Tilke

DATE:

REF NO. IQ03Q111FUS  
MMB REF NO. 1890-0113

## ASSIGNMENT

For good and valuable consideration, I, Uwe Rudolph, a citizen of Germany, residing at Altomsewitz 1e, 01157 Dresden, Germany, Martin Seck, a citizen of Germany, residing at Edeltraudstrasse 4, 81827 München, Germany, and Armin Tilke, a citizen of Germany, residing at Helgolandstrasse 4, 01097 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

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filed on August 12, 2004US. Serial No. 10/916,774entitled: Polysilicon Bipolar Transistor and Method of Manufacturing It

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

NAME: Uwe Rudolph

DATE: \_\_\_\_\_

SIGNATURE:

NAME: Martin Seck

DATE: \_\_\_\_\_

REF NO. 10030111PUS  
MMB REF NO. 1890-0115SIGNATURE: *Annin Tilke*

NAME: Annin Tilke

DATE: 01/07/2005